**Material Set Change:**

|  |  |  |  |
| --- | --- | --- | --- |
| **Package Material Set** | | **Carsem** | **Amkor** |
| MSOP | Die Attach | Ablestik 84-1LMISR4  LOCTITE QMI519 | Ablestik 8290 |
| Mold Compound | Sumitomo 6600  Sumitomo G600  Hitachi CEL 8240HF10LX | Sumitomo G700LS |